How Do Electronic Carriers Cross Si-Bound Alkyl Monolayers?

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(Received 19 May 2005; published 23 December 2005)

Electron transport through Si-C bound alkyl chains, sandwiched between n-Si and Hg, is characterized by two distinct types of barriers, each dominating in a different voltage range. At low voltage, the current depends strongly on temperature but not on molecular length, suggesting transport by thermionic emission over a barrier in the Si. At higher voltage, the current decreases exponentially with molecular length, suggesting transport limited by tunneling through the molecules. The tunnel barrier is estimated, from transport and photoemission data, to be ~1.5 eV with a 0.25meff effective mass.

DOI: 10.1103/PhysRevLett.95.266807
PACS numbers: 85.65.+h, 73.40.Qv, 73.61.Ph, 73.90.+f

A key issue in molecular electronics is the nature of electron transport through the organic molecules. Are multiple transport mechanisms or a single one operating, and are these mechanisms fundamentally new or known already in nonmolecular systems? Experimental results are often analyzed in terms of multiple mechanisms, and it is crucial to establish if this is justified or if, in doing so, new mechanisms are ignored. The situation is complicated by the strong dependence of the current through the molecular junction on the nature of the chemical bond to the electrodes [1–4]. Molecules, chemically bound to the semiconductor, are likely to affect the energy and density of surface states and, therefore, the semiconductor band bending [5]. Furthermore, the presence of a dipolar layer at the semiconductor/metal interface can affect the barrier for electron transport inside the semiconductor [6,7].

We show here that two mechanisms for electron transport occur in n-Si/alkyl monolayer/Hg junctions, where the molecules are bound via covalent Si-C bonds to Si. The two mechanisms are unambiguously distinguished and identified, as each dominates in a different range of applied voltage. We chose this semiconductor/molecule/metal system to optimize the possibility of observing current transport over the semiconductor/metal barrier and tunneling through the insulating organic monolayer barrier. There are several key features of the experimental system that allow one to carry out the desired experiments of current transport through molecules. First, the absence of an oxide between Si and the alkyl chain allows the direct study of the electrical properties of the monolayer itself. Second, Si presents a very smooth, reproducible, and well-controlled solid surface [8,9]. Third, well-prepared Si-C bonded alkyl monolayers are very stable [10], and suitably long alkyl chains form well-organized, nearly pinhole-free monolayers [10–12]. Fourth, the use of a metallic liquid Hg contact decreases the probability of formation of shorts in any remaining pinhole because of the high surface tension of liquid Hg [13–15]. Finally, the highly covalent Si-C bond, unlike the metal-thiolate bond, is a natural continuation of the alkyl chain. This feature minimizes potential discontinuities at the contacts [2,16]. The choice of Si as electrode also makes the system relevant to Si-based microelectronics.

Based on earlier data, we know that binding alkyl molecules to n-Si makes the Ohmic, molecule-free, n-Si:H/Hg contact rectifying [17,18]. Assuming that (i) rectification is due to a Schottky-type metal/semiconductor barrier and (ii) tunneling across the alkyl monolayer is so efficient that it does not limit the current at low applied voltage, where the Schottky barrier inside the semiconductor is still large, tunneling becomes the limiting step as the barrier decreases with increasing forward bias [19]. We test these assumptions by measuring and analyzing J-V curves as functions of temperature, using long chain alkyl molecules with different chain lengths in n-Si/alkyl monolayer/Hg junctions.

Si-C linked alkyl monolayers were formed by thermally induced hydrosilylation of alkenes with Si:H, adapting a procedure described elsewhere [11,20]. Si(111) substrates (1–10 Ω cm) were rinsed with organic solvents, blown dry under argon, cleaned in piranha solution (concentrated H2SO4: 30% H2O2, 3:1 v/v) at 90 °C for at least 20 min, and rinsed with deionized water (this procedure is essential to get high-quality monolayers, needed for reproducible electrical measurements). Samples were H-terminated by etching in 40% deoxygenated NH4F solution for 15–20 min. The resulting Si:H surfaces were immersed in the deoxygenated neat alkene under inert atmosphere and heated to 200 °C for at least 4 h. Control samples of monolayers on Si were characterized by atomic force microscopy, advancing water contact angle (CA), multi-wavelength, variable angle ellipsometry, Kelvin probe, x-ray photoelectron spectroscopy (XPS), and x-ray reflectivity. Empirically, we find the CA to be the simplest, fastest, and most reliable way to assess monolayer quality; i.e., highest (lowest) current densities are observed for junctions with lowest (highest) CA values [21]. Only monolayers with CA > 110° were used for electrical measure-
ments. Si-C linked molecular monolayers on Si were further analyzed by UV and inverse photoemission spectroscopy (UPS, IPES) to determine the position of the highest occupied and lowest unoccupied molecular orbitals (HOMO, LUMO) after monolayer formation. These measurements were followed by XPS measurements to assess any electron beam damage. Separate XPS measurements served to estimate band bending. The minor traces of O, found by analyzing the Cls, O1s, and Si 2p core levels, were identified, based on the energies of these levels, as adventitious O2 adsorbed on the monolayer’s outside; i.e., oxide buildup at the Si-monolayer interface is insignificant, even on samples exposed to air for weeks.

In Fig. 1, we show the log(J)-V characteristics of the series of n-Si/alkyl monolayer/Hg junctions [22]. Their shape clearly differs from earlier results on current transport through Si/alkyl chains/Hg junctions, which were described by thermionic emission with tunneling correction, without distinction between the mechanisms [18, 23–25]. While at low bias, the log(J)-V curves for our n-Si-CnH2m+1 || Hg (n = 12, 14, 16, 18) junctions are well-described by transport over a Schottky barrier, at higher forward bias (>0.6 V) there is a clear transition to a regime best described by tunneling [26]; i.e., there are two distinct types of barriers for current transport in the system. At low forward biases where current is limited by transport over the barrier inside the Si, the data clearly show that neither monolayer thickness nor molecular length play a discernible role in charge transport. However, at higher forward bias, the observed current depends on molecular length, as expected for tunneling [27, 28]. Such a transition agrees with simulations by Green et al. for a similar system, with a transparent conductor instead of Hg and SiO2 as insulator with varying thickness [29, 30]. Their simulations also show that the insulating layer thickness dictates how far the J-V characteristics deviate from those expected for transport over a Schottky barrier. Indeed, we find that the thicker the monolayer, the lower the voltage at which the current becomes tunneling-limited (cf. Fig. 1). Remarkably, the theoretically predicted behavior was difficult to observe with insulating Si oxide films [31, 32], as we could confirm for Hg/SiO2/n-Si junctions [33]. The reason is that the density of mobile charges in the oxide also scales with oxide thickness, a complication that is not encountered in the oxide-free system investigated here, in which the insulator is a molecular monolayer [34, 35].

The interpretation of the room temperature J-V characteristics was checked by temperature-dependent I-V measurements. Since Hg solidifies at ~235 K, measurements were done from 250 K up, with a high temperature limit of 330 K because of experimental limitations and toxicity of Hg vapors. We find that, at low voltage, the current increases exponentially with temperature, as expected for current transport over a Schottky barrier [36]. At high voltages, the current even decreases slightly with increasing temperature (inset in Fig. 1). We attribute this to a change in molecular tilt angle with temperature, as predicted by computations [37, 38].

The behavior of the n-Si-CnH2m+1 || Hg systems can be compared to that of the similar oxide-free n-Si:H || H2m+1Cn-S-Hg one (Fig. 1, dashed line), where the chains are chemically bound to Hg via the Hg-S bond and detached from the Si electrode, rather than chemically bound to the Si and detached from the Hg, as n-Si-C14H2g || Hg [23]. As the n-Si:H || H2gC14-S-Hg system has a negligible Schottky barrier inside the semiconductor [39], current through that junction is limited by tunneling only. Indeed, at low voltages the current through the n-Si:H || H2gC14-S-Hg junction is several orders of magnitude higher than that through the n-Si-C14H2g || Hg junction, where the current is limited by thermionic emission over the barrier inside the semiconductor. However, at higher voltages where charge transport is limited in both junctions by tunneling, the two J-V curves converge.

From the experimental data, we can extract separately the barrier inside the semiconductor φb and the barrier for tunneling through the molecular layer φt. φb is calculated using the thermionic emission or the more general thermionic emission-diffusion model [36]. In all cases, at room temperature and for applied bias V > ~75 mV, the following holds:

$$J \propto \exp\left(-\frac{q(n\phi_b - V)}{nkT}\right),$$

where J is the measured current density, q is the electron charge, and k is Boltzmann’s constant [23]. From the slope of the ln(J)-V plot, we find the ideality factor n ~ 1.5, and, from the intercept of this plot, φb ~ 0.8 V. As the effective barrier (nφb-V) decreases with increasing V, the effect of φb decreases, and tunneling through the organic molecular layer becomes the limiting factor.

FIG. 1. Experimental J-V curves for n-Si-CnH2m+1 || Hg (n = 12, 14, 16, 18) junctions at forward bias. Dashed line: n-Si:H || H2gC14-S-Hg junction. Contact area: 0.1 mm2. Curves are the average for ~20 junctions. The error is 10%. Inset: Temperature dependence of J-V curves for n-Si-C14H2g || Hg over the same voltage span [36, 37].

PRL 95, 266807 (2005)
PHYSICAL REVIEW LETTERS
week ending 31 DECEMBER 2005
To describe the current in the tunneling-limited regime, we use Simmons’s model for tunneling through a rectangular barrier, where the observed current depends exponentially on $d$, the tunneling distance, and on $\beta$, the inverse tunneling decay length [27,28]:

$$J = J_0 e^{-\beta d}. \quad (2)$$

For a rectangular barrier, $\beta$ is expected to depend on applied voltage according to Refs. [27,28]:

$$\beta = 4\pi \sqrt{\frac{2m^*(\phi_t - \phi_e)}{\hbar^2}}. \quad (3)$$

where $m^*$ is the electron effective mass and $h$ is Planck’s constant. From Eq. (3), $\beta$ should decrease as $V$ increases. While experimentally no dependence [40] or an opposite one is often found [23], the system studied here shows the expected dependence, as illustrated by the linear $\beta^2$-$V$ plot in Fig. 2.

Such dependence was also reported for alkyl monolayers attached on one side to nanometer-sized Au contacts [41]. By extrapolating the $\beta^2$-$V$ plot to $V = 0$, we can evaluate $\phi_t$ and $m^*$ for tunneling through the molecular insulator. The slope of the $\beta^2$-$V$ plot yields $m^* = 0.25 \pm 0.02m_e$, similar to some experimental results and theoretical calculations [41–43]. With this value and the $\beta^2$-$V$ plot intercept, we find $\phi_t = 1.5 \pm 0.5$ eV. We stress that these $\phi_t$ and $m^*$ values are not absolute ones because of uncertainties regarding barrier shape and junction symmetry, factors that are included in $m^*$ in the theoretical model [2,41].

To extract absolute values for $\phi_t$ and $m^*$, we need an independent measurement of one of these quantities. The barrier height for electron transport through the LUMO was obtained from IPES measurements [44] on the $n$-Si-C$_{14}$H$_{2n+1}$ and $n$-Si-C$_{16}$ systems. These show the LUMO at $2.2 \pm 0.3$ eV above the Fermi level ($E_F$), yielding a tunneling barrier between the conduction band edge ($E_{CB}$) and the LUMO [36] of $\approx 1.4 \pm 0.3$ eV, after taking into account that the Schottky barrier $E_{CB}$-$E_F$ ($=\phi_b$) is $\approx 0.8$ eV. The 1.4 eV value is in good agreement with $\phi_t$ derived from the transport data. We note that the low $m^*$ ($=0.25m_e$) implies that the effective barrier for tunneling is much lower than $\phi_t$.

The band diagram for the $n$-Si-C$_{14}$H$_{2n+1}$ || Hg system is constructed with the LUMO position given above, the Schottky barrier found from the $I$-$V$ measurements, and a 1.1 eV Si band gap (Fig. 3). The HOMO position, determined by UPS, is $3.2 \pm 0.3$ eV below the Fermi level or $2.9 \pm 0.3$ eV below the valence band edge ($E_{CB}$-$E_F$ $\approx 0.8$ eV). The HOMO-LUMO gap is then estimated at $5.4 \pm 0.5$ eV, significantly less than the $9–10$ eV free alkyl chain value [42]. The reduction in ionization energy and increase in electron affinity for the condensed molecule is, to a great extent, due to the stabilizing effect of electronic polarization in the metal or dielectric substrate and in the molecular layer [45]. Furthermore, in a molecular orbital picture, chemical bond formation between the Si surface and the free molecules involves new orbitals for the (Si + molecule) system, resulting from interactions between the molecule frontier orbitals and the semiconductor surface state levels (cf. Ref. [5]), leading to a HOMO-LUMO gap of the (Si + molecule) system that is smaller than that of the free molecule.

![FIG. 2 (color online). $\beta^2$ vs forward bias at high voltages, derived from the data shown in Fig. 1 and Eqs. (2) and (3). The solid line shows the best linear fit.](image)

![FIG. 3 (color online). Proposed band diagram for the $n$-Si-C$_{14}$H$_{2n+1}$ || Hg system from UPS, IPES, and $I$-$V$ data. ($E_{CB}$-$E_F$) $= 0.25$ eV. Experimental uncertainties in HOMO and LUMO values are indicated. The work functions are 4.3 eV (Si) and 4.5 eV (Hg). From UPS and XPS, we find $\approx 0.4$ eV band bending before making Hg contact. The $\approx 0.8$ eV Schottky barrier implies that band bending increases to $\approx 0.5$ eV. As the LUMO was found to be $\approx 2.2 \pm 0.3$ eV above $E_F$, it is $1.4 \pm 0.3$ eV above the Si $E_{CB}$.](image)
In summary, our results show that two distinct electron transport mechanisms operate in the $n$-Si-C$_{6}H_{2n+1}$∥Hg molecular system. At low forward bias voltages, current is limited by transport over a Schottky barrier in the semiconductor. At higher forward bias, current is limited by tunneling through the organic molecular layer. The thinner the molecular layer, the higher the voltage at which the tunnel current starts to dominate [46,47].

The molecules in the $n$-Si-C$_{6}H_{2n+1}$∥Hg junction are more ideally insulating than native Si oxide. This may be of interest, for example, in solar cell applications [30]. By using more sophisticated molecules and combining the alkyl chain framework with dipolar molecules [6], it should be possible to achieve molecular control over both transport via tunneling and transport over the barrier in the system.

We thank L. Kronik (WIS), Y. Selzer and A. Nitzan (Tel Aviv University) for helpful discussions; M. Gal (UNSW) for critical reading of the manuscript; A. Yoffe for technical assistance; the Clore Foundation for financial support for critical reading of the manuscript; A. Yoffe for technical assistance; the Clore Foundation for financial support to A. S.; the Israel Science Foundation (Jerusalem), Minerva Foundation (Munich), and the Philip M. Klutznick Research Fund for support to D. C.; the National Science Foundation (DMR-0408589), the Princeton MRSEC (DMR-0213706), and the New Jersey Center for Organic Optoelectronics for support to A. K.; and the Australian Research Council for support to T. B.

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17. The $n$-Si/Hg junction is Ohmic; i.e., there is no Schottky barrier at the Si surface at zero applied bias. See also Ref. [18].
19. The process can be viewed as a two-step reaction, where each step can be rate-determining, depending on, in our case, the applied potential difference between the semiconductor and the metal.
21. This result implies that, before interpreting trends, observed if the molecular length is changed, possible differences in monolayer quality should be excluded.
22. Each junction was measured at least 3 times in a double scan mode to check for possible hysteresis and assure its stability. Deviations from the average were less than half an order of magnitude. We note that molecular adsorption prevents, or at least seriously retards, the oxidation of the free Si surface.
26. Note that in this study we use longer alkyl chains than those that were used in earlier reports, so as to assure the highest quality monolayers.
34. Earlier studies on CdTe/fatty acid layer/Au junctions were insufficient to test the theoretical predictions [35].
37. Theoretical calculations (cf. Ref. [38]) show that, for the Si-C$_{10}H_{17}$ monolayer, the tilt angle decreases with the temperature. For example, at 255 and 330 K, the monolayer thickness was calculated to be 17.95 and 18.23 Å, respectively.
46. Similarly, whether electron transfer in a molecule is through-bond or through-space tunneling, it was found to depend on the electron’s electrochemical potential difference between the sides of the system, tunneled through (cf. [47]).